Excellent Integrated System Limited

Stocking Distributor

Click to view price, real time Inventory, Delivery & Lifecycle Information:

Microsemi Power Products CPT30050

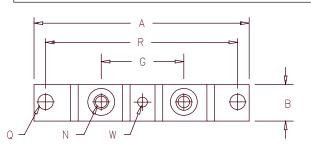
For any questions, you can email us directly: sales@integrated-circuit.com

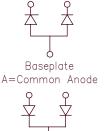


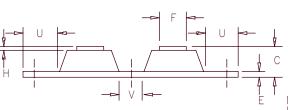
Datasheet of CPT30050 - DIODE MODULE 50V 150A 2TOWER

Schottky PowerMod CPT30035 — CPT30050

Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com







Baseplate
Common Cathode

Baseplate
D=Doubler

Notes: Baseplate: Nickel plated copper

Dim. In	ches	Millir	meters	
Min.	Max.	Min.	Max.	Notes
A B 0.700 C E 0.120 F 0.490 G 1.375	0.800 0.630 0.130 0.510	3.05 12.45	12.95	
H 0.010 N Q 0.275 R 3.150 U 0.600 V 0.312 W 0.180	0.340	6.99 80.01 15.24 7.92		1/4-20 Dia.

Microsemi Catalog Number		Working Peak Reverse Voltage	Repetitive Peak Reverse Voltage
CPT30035* CPT30040* CPT30045*	301CNQ035 301CNQ040 301CNQ045 MBRP30045CT	35V 40V 45V	35V 40V 45V
CPT30050*		50V	50V
*Add Suf	fix A for Comr	mon Anode, D for	Doubler

- Schottky Barrier Rectifier
- Guard Ring Protection
- 300 Amperes/35 to 50 Volts
- 175°C Junction Temperature
- Reverse Energy Tested
- ROHS Compliant

Electrical Characteristics

F(AV) 300 Amps Average forward current per pkg |F(AV) 150 Amps Average forward current per leg IFSM 2000 Amps Maximum surge current per leg Maximum repetitive reverse current per leg \R(0V)2 Amps **VFM** 0.70 Volts Max peak forward voltage per leg V_{FM} Max peak forward voltage per leg 0.76 Volts ^IRM 75 mA Max peak reverse current per leg ^IRM Max peak reverse current per leg 4.0 mA C_{J} 4600 pF Typical junction capacitance per leg

TC = 136°C, Square wave, ReJC = 0.20°C/W TC = 136°C, Square wave, ReJC = 0.40°C/W 8.3ms, half sine, TJ = 175°C f = 1 KHZ, 25°C | FM = 200A:TJ = 125°C* | FM = 200A:TJ = 25°C* | VRRM, TJ = 125°C* | VRRM, TJ = 25°C | VR = 5.0V, TC = 25°C

*Pulse test: Pulse width 300µsec, Duty cycle 2%

Thermal and Mechanical Characteristics

TSTG Storage temp range -55°C to 175°C ΤJ Operating junction temp range -55°C to 175°C R OJC Max thermal resistance per leg 0.40°C/W Junction to case R OJC Max thermal resistance per pkg 0.20°C/W Junction to case Recs 0.08°C/W Case to sink Typical thermal resistance (greased) Terminal Torque 35-40 inch pounds Mounting Base Torque (outside holes) Mounting Base Torque (center hole) center hole must be torqued first 30-40 inch pounds 8-10 inch pounds Weight 2.8 ounces (75 grams) typical

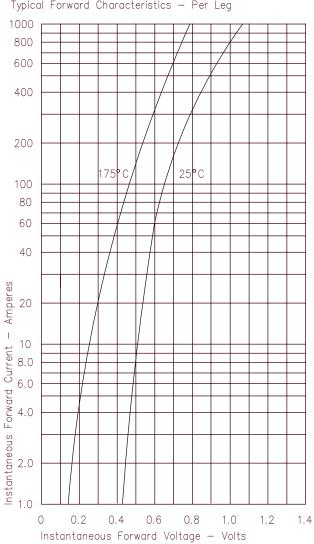




Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

CPT30035 - CPT30050

Figure 1 Typical Forward Characteristics — Per Leg



Typical Junction Capacitance - Per Leg 100,000 60,000 40,000 20,000 Junction Capacitance 10,000 6000 4000 2000 1000 50 0.1 0.5 1.0 5.0 10 100 Reverse Voltage - Volts

Forward Current Derating — Per Leg

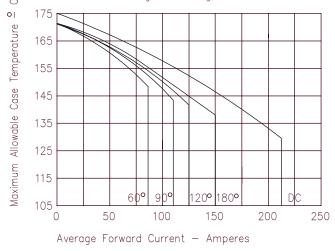


Figure 2 Typical Reverse Characteristics — Per Leg

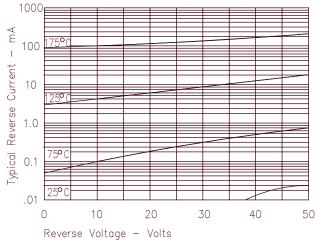
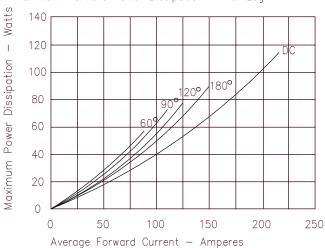


Figure 5
Maximum Forward Power Dissipation — Per Leg





Distributor of Microsemi Power Products: Excellent Integrated System Limited Datasheet of CPT30050 - DIODE MODULE 50V 150A 2TOWER

Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

DISCLAIMER

The information contained in the document (unless it is publicly available on the Web without access restrictions) is PROPRIETARY AND CONFIDENTIAL information of Microsemi and cannot be copied, published, uploaded, posted, transmitted, distributed or disclosed or used without the express duly signed written consent of Microsemi. If the recipient of this document has entered into a disclosure agreement with Microsemi, then the terms of such Agreement will also apply. This document and the information contained herein may not be modified, by any person other than authorized personnel of Microsemi. No license under any patent, copyright, trade secret or other intellectual property right is granted to or conferred upon you by disclosure or delivery of the information, either expressly, by implication, inducement, estoppels or otherwise. Any license under such intellectual property rights must be approved by Microsemi in writing signed by an officer of Microsemi.

Microsemi reserves the right to change the configuration, functionality and performance of its products at anytime without any notice. This product has been subject to limited testing and should not be used in conjunction with life-support or other mission-critical equipment or applications. Microsemi assumes no liability whatsoever, and Microsemi disclaims any express or implied warranty, relating to sale and/or use of Microsemi products including liability or warranties relating to fitness for a particular purpose, merchantability, or infringement of any patent, copyright or other intellectual property right. Any performance specifications believed to be reliable but are not verified and customer or user must conduct and complete all performance and other testing of this product as well as any user or customers final application. User or customer shall not rely on any data and performance specifications or parameters provided by Microsemi. It is the customer's and user's responsibility to independently determine suitability of any Microsemi product and to test and verify the same. The information contained herein is provided "AS IS, WHERE IS" and with all faults, and the entire risk associated with such information is entirely with the User. Microsemi specifically disclaims any liability of any kind including for consequential, incidental and punitive damages as well as lost profit. The product is subject to other terms and conditions which can be located on the web at http://www.microsemi.com/legal/tnc.asp

Life Support Application

Seller's Products are not designed, intended, or authorized for use as components in systems intended for space, aviation, surgical implant into the body, in other applications intended to support or sustain life, or for any other application in which the failure of the Seller's Product could create a situation where personal injury, death or property damage or loss may occur (collectively "Life Support Applications").

Buyer agrees not to use Products in any Life Support Applications and to the extent it does it shall conduct extensive testing of the Product in such applications and further agrees to indemnify and hold Seller, and its officers, employees, subsidiaries, affiliates, agents, sales representatives and distributors harmless against all claims, costs, damages and expenses, and attorneys' fees and costs arising, directly or directly, out of any claims of personal injury, death, damage or otherwise associated with the use of the goods in Life Support Applications, even if such claim includes allegations that Seller was negligent regarding the design or manufacture of the goods.

Buyer must notify Seller in writing before using Seller's Products in Life Support Applications. Seller will study with Buyer alternative solutions to meet Buyer application specification based on Sellers sales conditions applicable for the new proposed specific part.